15A, 1200V SiC Merged PIN Schottky Diode

FEATURES

- AEC-Q101 qualified
- Max junction temperature 175°C
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V_F
- RoHS compliant
- Halogen-free

APPLICATIONS

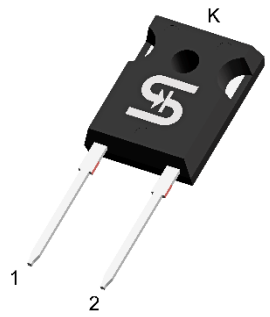
- General purpose
- Switch mode power supplies
- Power factor correction

MECHANICAL DATA

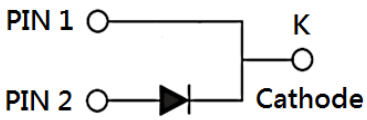
- Case: TO-247-2L
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As circuit diagram
- Weight: 6.10g (approximately)

KEY PARAMETERS		
PARAMETER	**VALUE**	**UNIT**
I_F	15	A
V_{RRM}	1200	V
I_{FSM}	148	A
$T_{J\ MAX}$	175	°C
Package	TO-247-2L	
Configuration	Single die	

Pb-Free RoHS COMPLIANT HALOGEN FREE



TO-247-2L



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER		SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		V_{RRM}	1200	V
Reverse voltage, total rms value		$V_{R(RMS)}$	840	V
Forward current		I_F	15	A
Surge peak forward current 10ms single half sine-wave superimposed on rated load	T_C = 25°C	I_{FSM}	148	A
	T_C = 150°C		131	A
Non-repetitive peak forward surge current	t_p = 10μs	$I_{F,\ MAX}$	1158	A
Junction temperature		T_J	-55 to +175	°C
Storage temperature		T_{STG}	-55 to +175	°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	MAX	UNIT
Junction-to-case thermal resistance	$R_{\theta JC}$	0.76	0.91	°C/W

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage(1)	I_F = 7.5A, T_J = 25°C	V_F	1.16	-	V
	I_F = 15A, T_J = 25°C		1.38	1.50	V
	I_F = 7.5A, T_J = 150°C		1.30	-	V
	I_F = 15A, T_J = 150°C		1.81	2.10	V
	I_F = 7.5A, T_J = 175°C		1.35	-	V
	I_F = 15A, T_J = 175°C		1.95	-	V
Reverse current @ rated V_R(2)	T_J = 25°C	I_R	-	30	μA
	T_J = 175°C		-	100	μA
Junction capacitance	f = 1MHz, V_R = 1V	C_J	1112	-	pF
	f = 1MHz, V_R = 800V		56	-	pF
Capacitive Charge	V_R = 800V	Q_C	74	-	nC

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSCDAH15120G2H	TO-247-2L	30 / Tube

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Typical Forward Characteristics

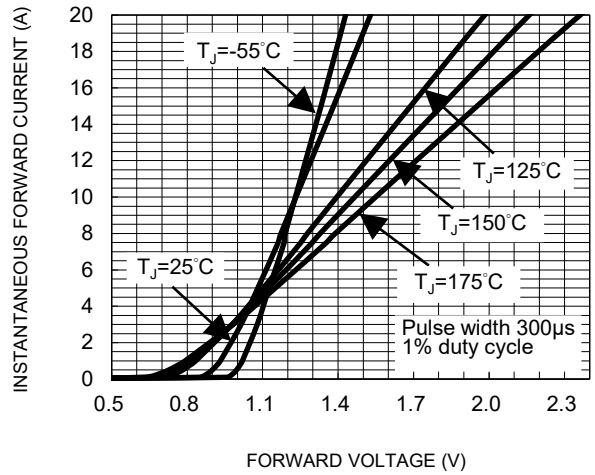


Fig.2 Typical Reverse Characteristics

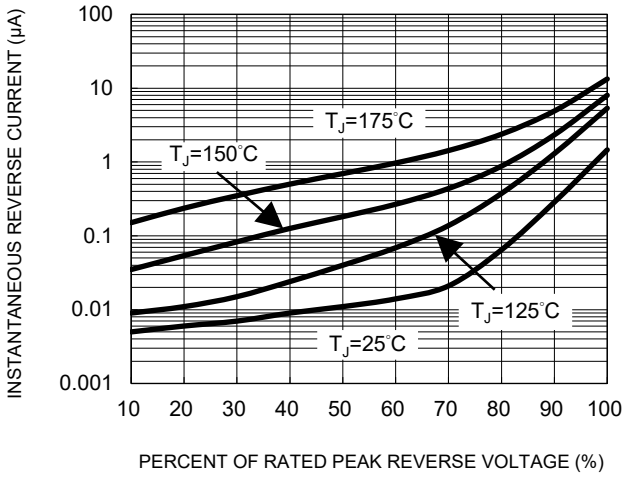


Fig.3 Peak forward current versus case temperature

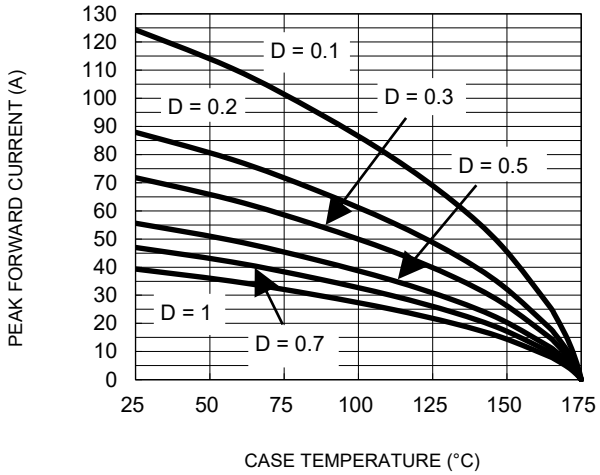


Fig.4 Typical Junction Capacitance

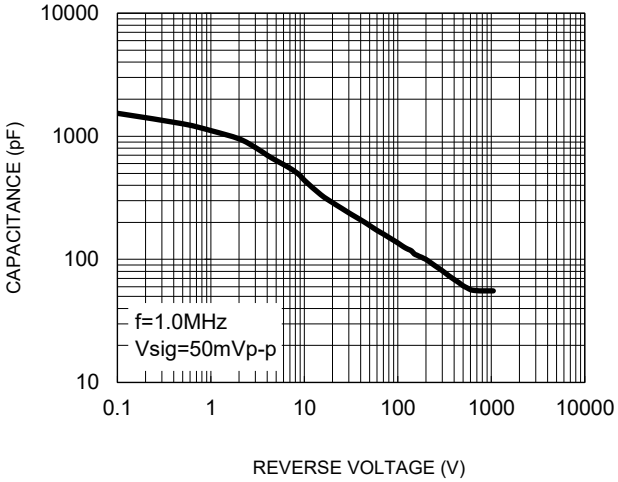


Fig.5 Typical Capacitive Charge

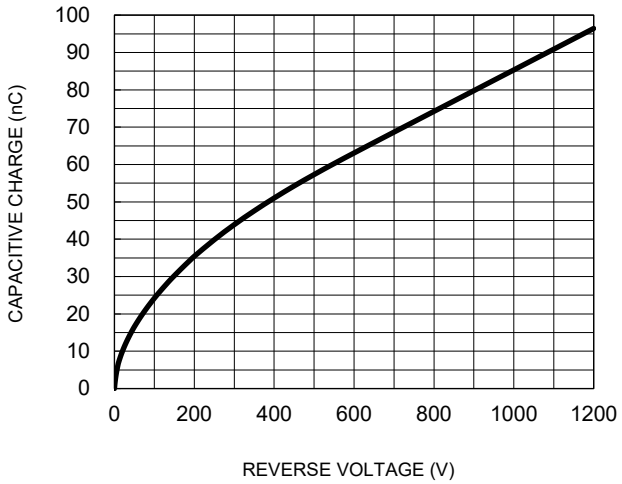
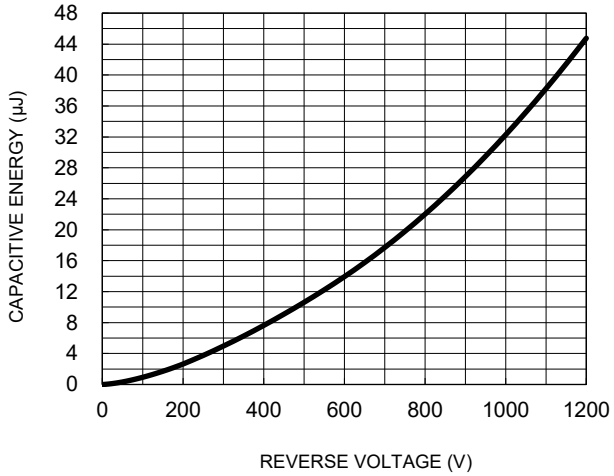


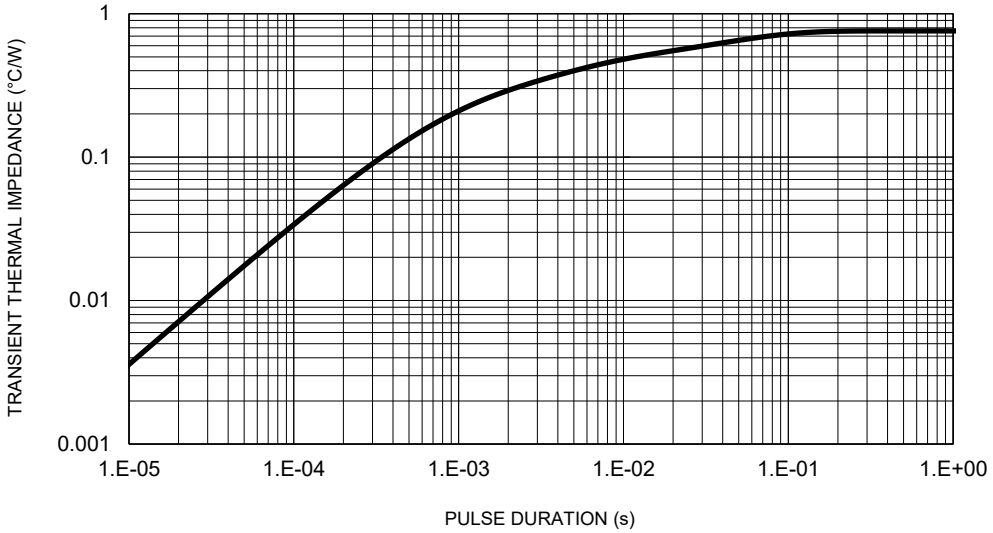
FIG.6 Typical Capacitance Stored Energy



CHARACTERISTICS CURVES

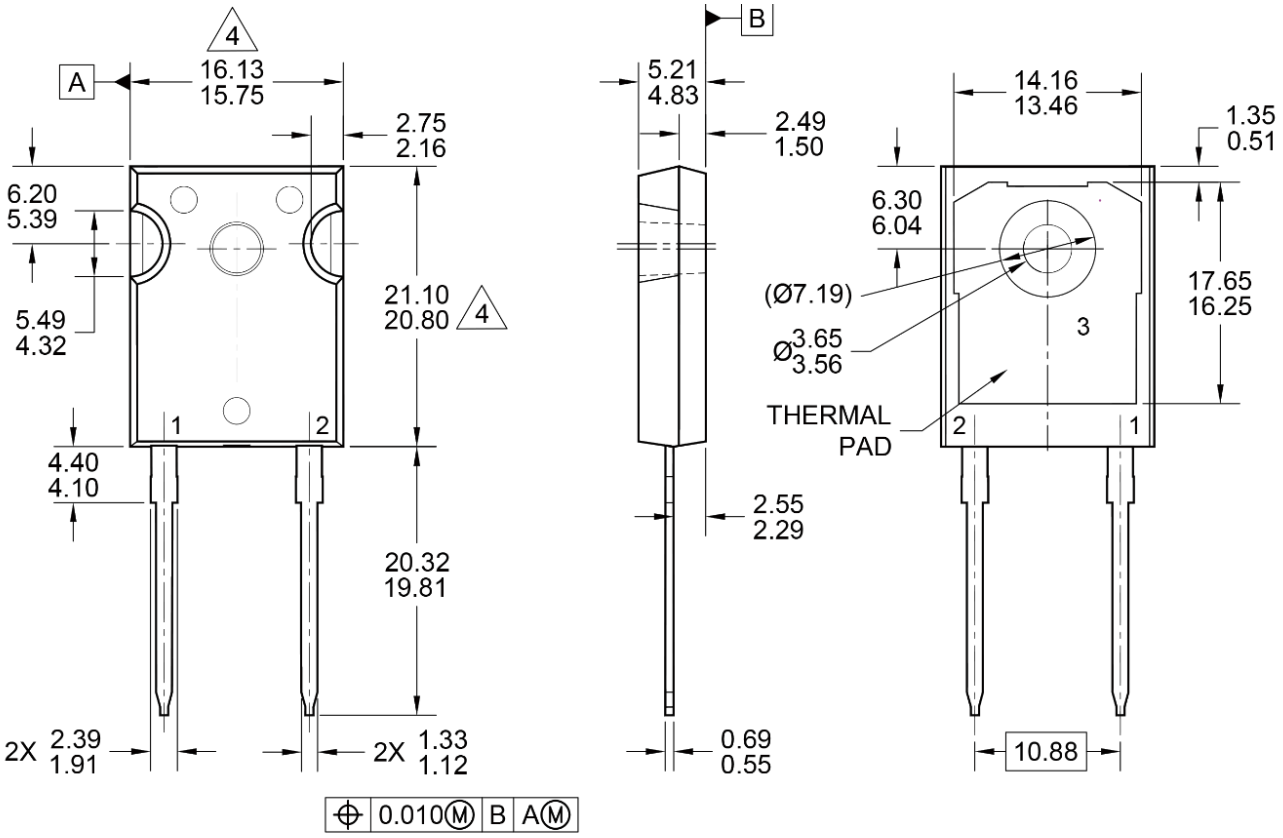
(T_A = 25°C unless otherwise noted)

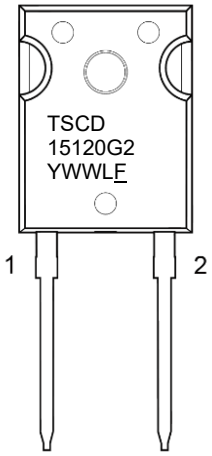
Fig.7 Typical Transient Thermal Characteristics



PACKAGE OUTLINE DIMENSIONS

TO-247-2L





MARKING DIAGRAM

Y	= Year Code
WW	= Week Code (01~52)
L	= Lot Code (1~9,A~Z)
F	= Factory Code

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC TO-247, VARIATION BD, ISSUE F.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
5. DWG NO. REF: HQ2SD07-TO247BDSiC-129 REV A.

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